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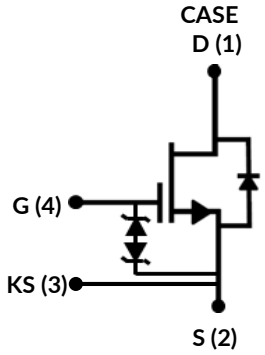
DATASHEET

UF3C120150K4S



Part Number	Package	Marking
UF3C120150K4S	TO-247-4L	UF3C120150K4S

1200V-150mΩ SiC Cascode

Rev. A, April 2019

Description

United Silicon Carbide's cascode products co-package its high-performance F3 SiC fast JFETs with a cascode optimized MOSFET to produce the only standard gate drive SiC device in the market today. This series exhibits very fast switching using a 4-terminal TO-247-package and the best reverse recovery characteristics of any device of similar ratings. These devices are excellent for switching inductive loads, and any application requiring standard gate drive.

Features

- Typical on-resistance $R_{DS(on),typ}$ of 150mΩ
- Maximum operating temperature of 175°C
- Excellent reverse recovery
- Low gate charge
- Low intrinsic capacitance
- ESD protected, HBM class 2
- TO-247-4L package for faster switching, clean gate waveforms

Typical applications

- EV charging
- PV inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

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Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V_{DS}		1200	V
Gate-source voltage	V_{GS}	DC	-25 to +25	V
Continuous drain current [1]	I_D	T_C = 25°C	18.4	A
		T_C = 100°C	13.8	A
Pulsed drain current [2]	I_{DM}	T_C = 25°C	38	A
Single pulsed avalanche energy [3]	E_{AS}	L=15mH, I_{AS} =2A	30	mJ
Power dissipation	P_{tot}	T_C = 25°C	166.7	W
Maximum junction temperature	$T_{J,max}$		175	°C
Operating and storage temperature	T_J, T_{STG}		-55 to 175	°C
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T_L		250	°C

1. Limited by $T_{J,max}$
2. Pulse width t_p limited by $T_{J,max}$
3. Starting T_J = 25°C

Thermal Characteristics

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.7	0.9	°C/W

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Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Drain-source breakdown voltage	BV_{DS}	V_{GS}=0V, I_D=1mA	1200			V
Total drain leakage current	I_{DSS}	V_{DS}=1200V, V_{GS}=0V, T_J=25°C		2	50	µA
		V_{DS}=1200V, V_{GS}=0V, T_J=175°C		17		
Total gate leakage current	I_{GSS}	V_{DS}=0V, T_J=25°C, V_{GS}=-20V / +20V		4	620	µA
Drain-source on-resistance	$R_{DS(on)}$	V_{GS}=12V, I_D=5A, T_J=25°C		150	180	mΩ
		V_{GS}=12V, I_D=5A, T_J=175°C		330		
Gate threshold voltage	$V_{G(th)}$	V_{DS}=5V, I_D=10mA	3.5	4.4	5.5	V
Gate resistance	R_G	f=1MHz, open drain		4.6		Ω

Typical Performance - Reverse Diode

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Diode continuous forward current [1]	I_S	T_C=25°C			18.4	A
Diode pulse current [2]	$I_{S,pulse}$	T_C=25°C			38	A
Forward voltage	V_{FSD}	V_{GS}=0V, I_F=5A, T_J=25°C		1.46	2	V
		V_{GS}=0V, I_F=5A, T_J=175°C		2		
Reverse recovery charge	Q_{rr}	V_R=800V, I_F=13A, V_{GS}=-5V, R_{G_EXT}=22Ω di/dt=1700A/µs, T_J=25°C		67		nC
Reverse recovery time	t_{rr}			24		ns
Reverse recovery charge	Q_{rr}	V_R=800V, I_F=13A, V_{GS}=-5V, R_{G_EXT}=22Ω di/dt=1700A/µs, T_J=150°C		64		nC
Reverse recovery time	t_{rr}			24		ns

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Typical Performance - Dynamic

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Input capacitance	C_{iss}	V_{DS}=100V, V_{GS}=0V f=100kHz		738		pF
Output capacitance	C_{oss}			58		
Reverse transfer capacitance	C_{rss}			1.8		
Effective output capacitance, energy related	$C_{oss(er)}$	V_{DS}=0V to 800V, V_{GS}=0V		34		pF
Effective output capacitance, time related	$C_{oss(tr)}$	V_{DS}=0V to 800V, V_{GS}=0V		68		pF
C_{OSS} stored energy	E_{oss}	V_{DS}=800V, V_{GS}=0V		10.8		µJ
Total gate charge	Q_G	V_{DS}=800V, I_D=13A, V_{GS} = -5V to 12V		25.7		nC
Gate-drain charge	Q_{GD}			6		
Gate-source charge	Q_{GS}			10		
Turn-on delay time	$t_{d(on)}$	V_{DS}=800V, I_D=13A, Gate Driver =-5V to +12V, Turn-on $R_{G,EXT}$=8.5Ω, Turn-off $R_{G,EXT}$=22Ω Inductive Load, FWD: same device with V_{GS}=-5V, R_G=22Ω, T_J=25°C		21		ns
Rise time	t_r			8		
Turn-off delay time	$t_{d(off)}$			26		
Fall time	t_f			8		
Turn-on energy	E_{ON}			170		µJ
Turn-off energy	E_{OFF}			26		
Total switching energy	E_{TOTAL}			196		
Turn-on delay time	$t_{d(on)}$	V_{DS}=800V, I_D=13A, Gate Driver =-5V to +12V, Turn-on $R_{G,EXT}$=8.5Ω, Turn-off $R_{G,EXT}$=22Ω Inductive Load, FWD: same device with V_{GS}=-5V, R_G=22Ω, T_J=150°C		18		ns
Rise time	t_r			6		
Turn-off delay time	$t_{d(off)}$			26		
Fall time	t_f			7		
Turn-on energy	E_{ON}			152		µJ
Turn-off energy	E_{OFF}			26		
Total switching energy	E_{TOTAL}			178		

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Typical Performance Diagrams

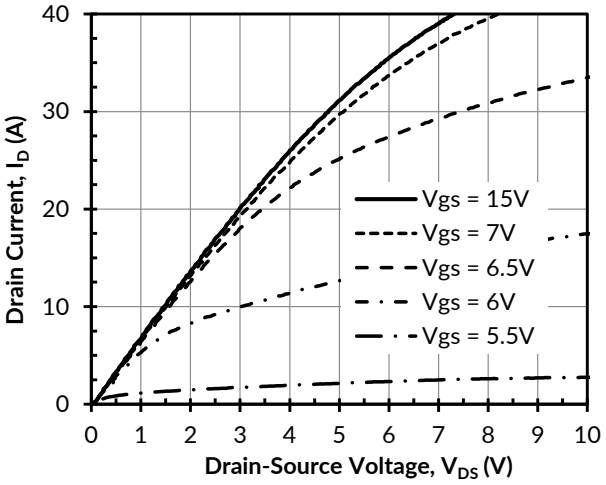

Figure 1. Typical output characteristics at T_J = -55°C, tp < 250µs

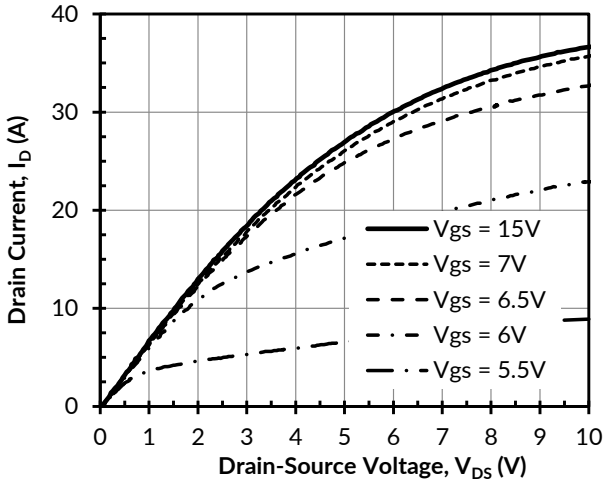

Figure 2. Typical output characteristics at T_J = 25°C, tp < 250µs

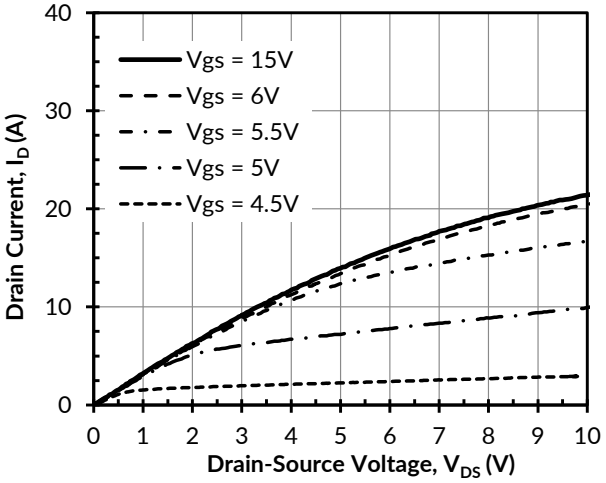

Figure 3. Typical output characteristics at T_J = 175°C, tp < 250µs

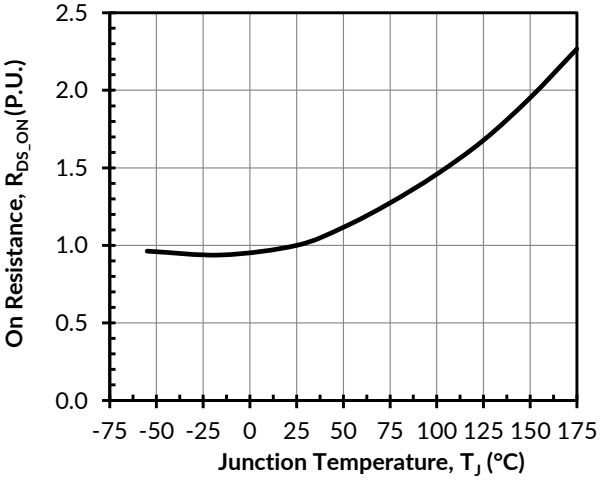

Figure 4. Normalized on-resistance vs. temperature at V_{GS} = 12V and I_D = 5A

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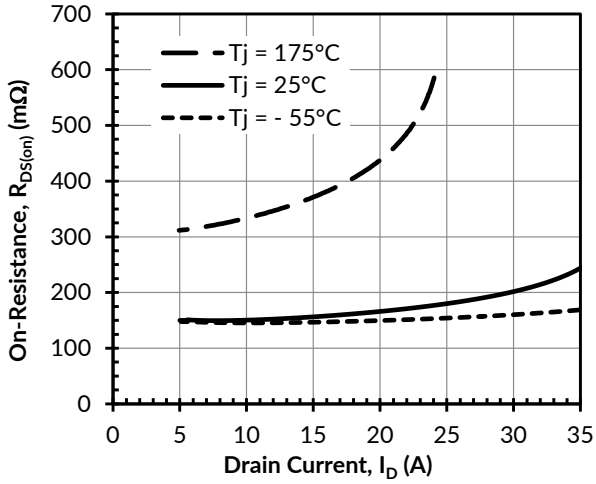

Figure 5. Typical drain-source on-resistances at V_{GS} = 12V

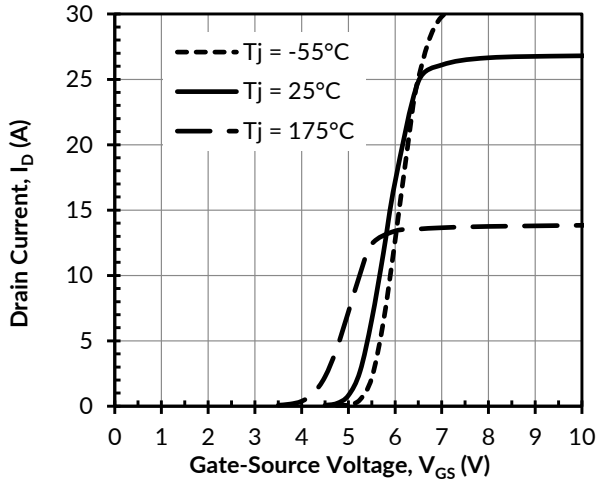

Figure 6. Typical transfer characteristics at V_{DS} = 5V

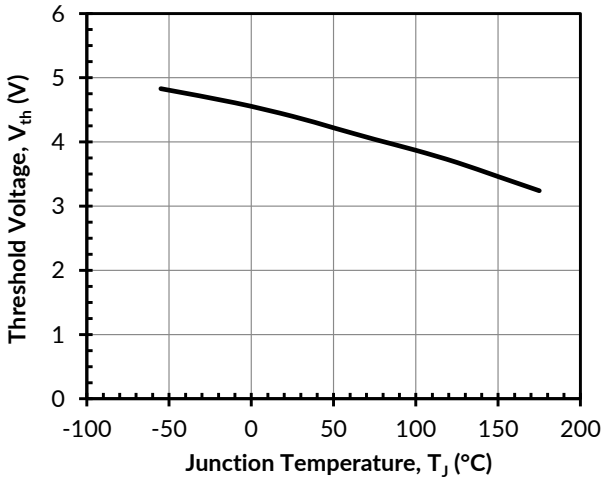

Figure 7. Threshold voltage vs. junction temperature at V_{DS} = 5V and I_D = 10mA

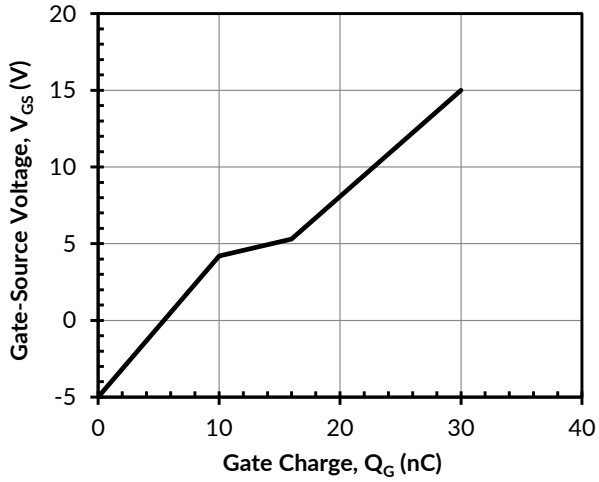

Figure 8. Typical gate charge at V_{DS} = 800V and I_D = 13A

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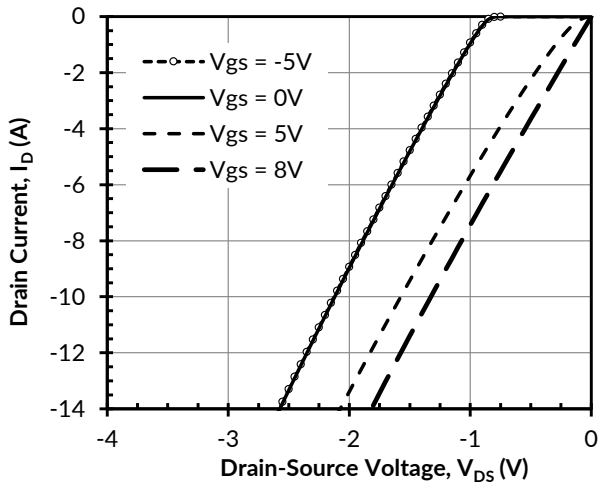

Figure 9. 3rd quadrant characteristics at T_J = -55°C

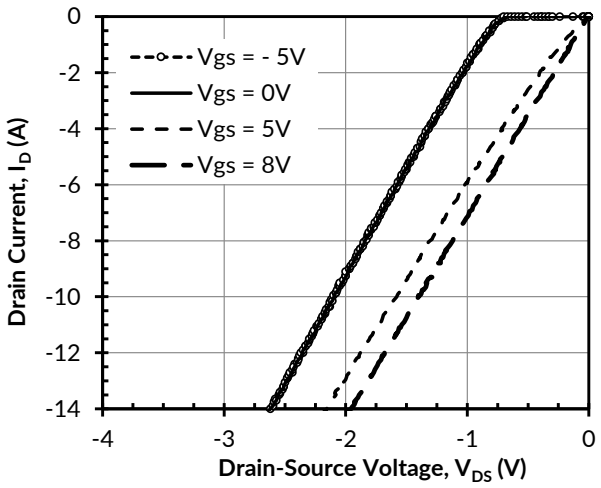

Figure 10. 3rd quadrant characteristics at T_J = 25°C

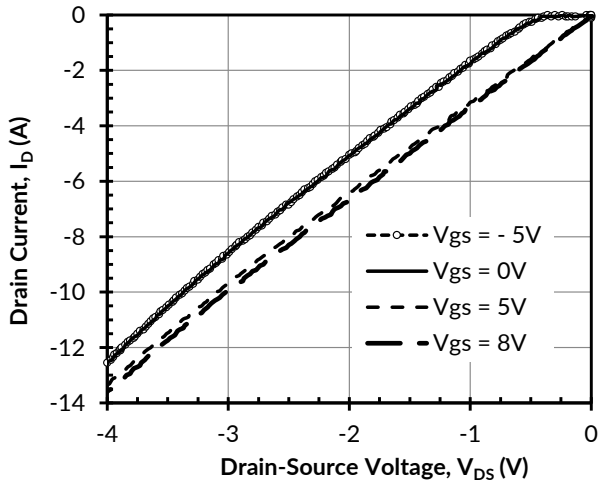

Figure 11. 3rd quadrant characteristics at T_J = 175°C

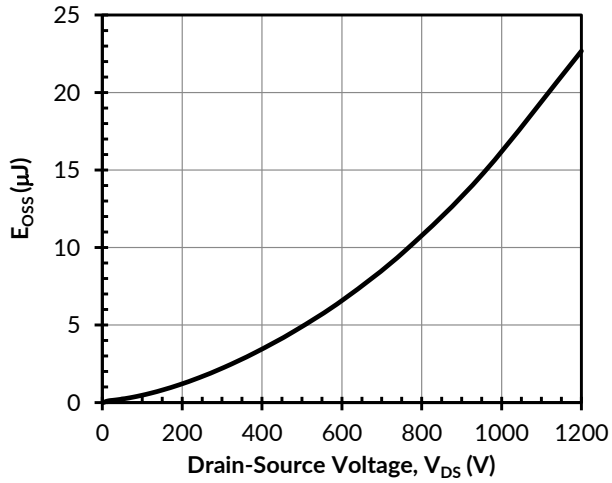

Figure 12. Typical stored energy in C_{OSS} at V_{GS} = 0V

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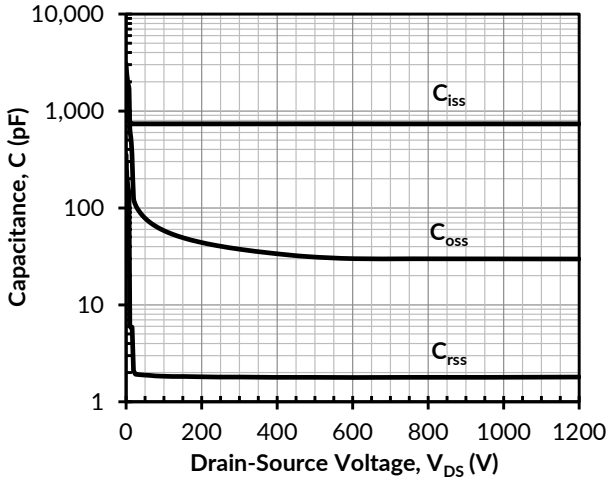

Figure 13. Typical capacitances at f = 100kHz and V_{GS} = 0V

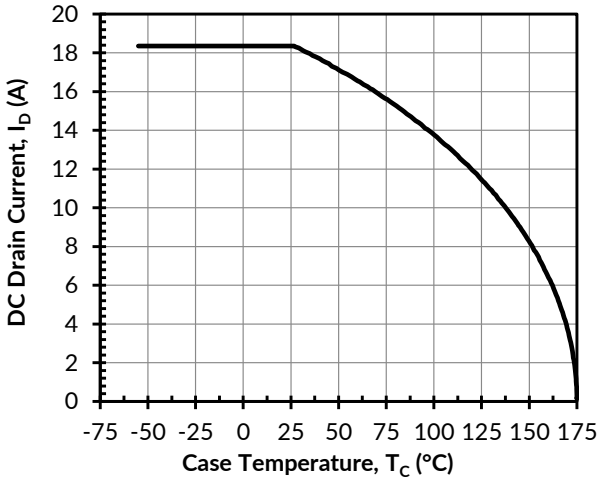

Figure 14. DC drain current derating

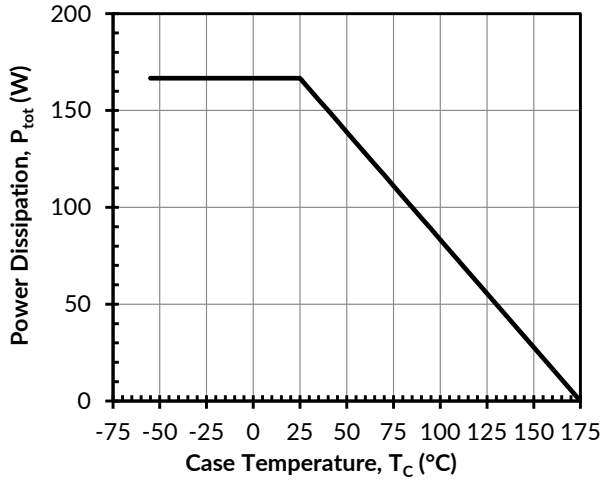

Figure 15. Total power dissipation

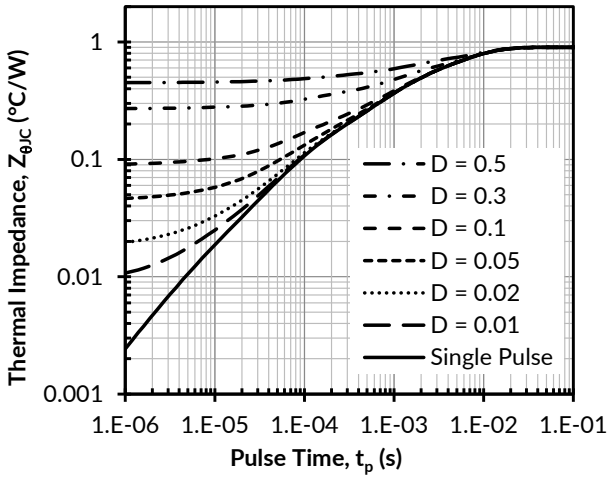

Figure 16. Maximum transient thermal impedance

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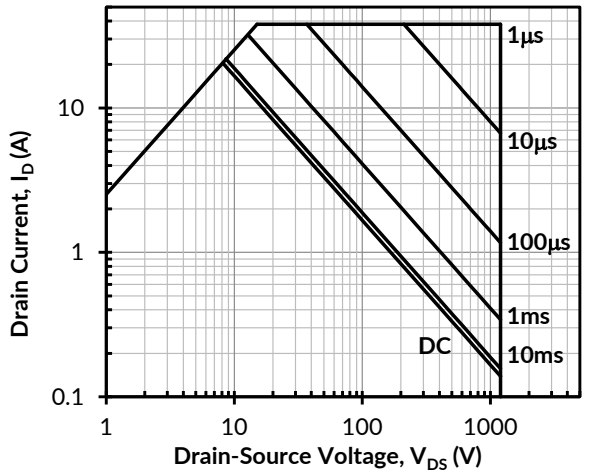

Figure 17. Safe operation area at T_C = 25°C, D = 0, Parameter t_p

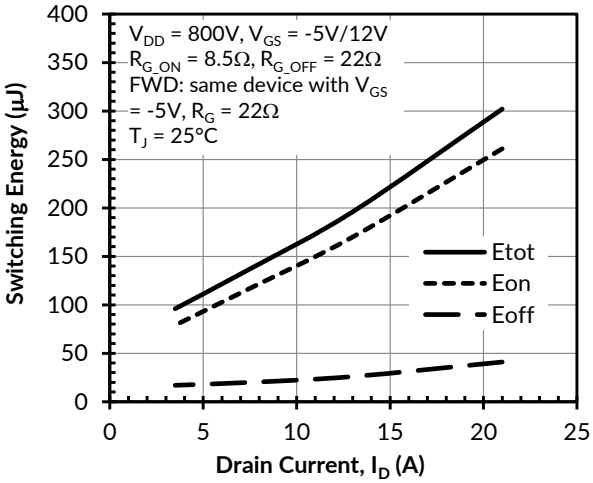

Figure 18. Clamped inductive switching energy vs. drain current at T_J = 25°C

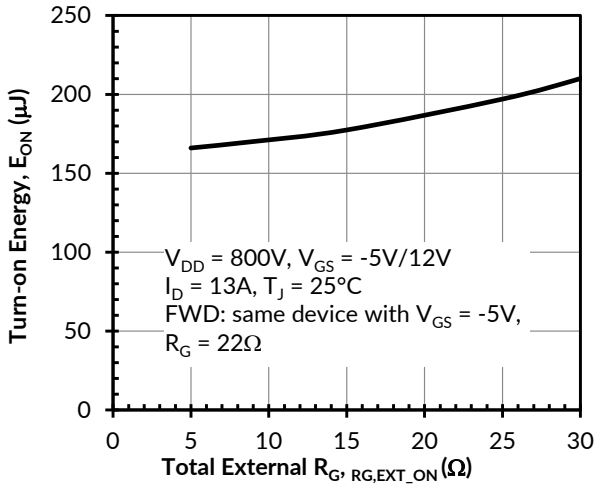

Figure 19. Clamped inductive switching turn-on energy vs. R_{G,EXT_ON}

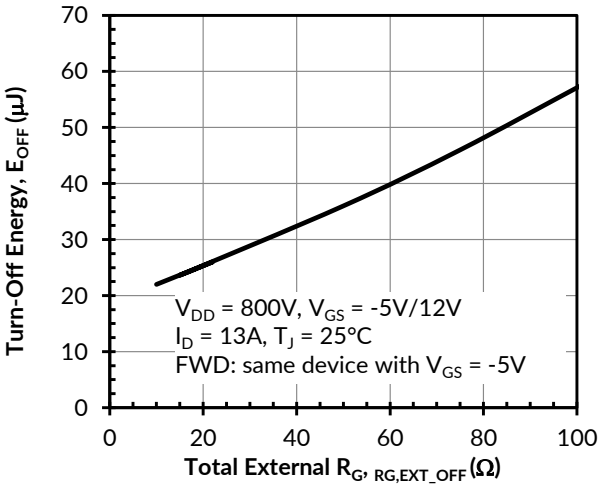

Figure 20. Clamped inductive switching turn-off energy vs. R_{G,EXT_OFF}

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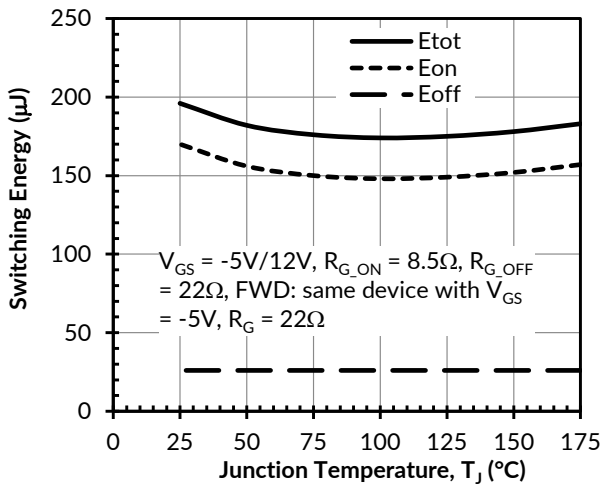

Figure 21. Clamped inductive switching energy vs. junction temperature at V_{DS} = 800V and I_D = 13A

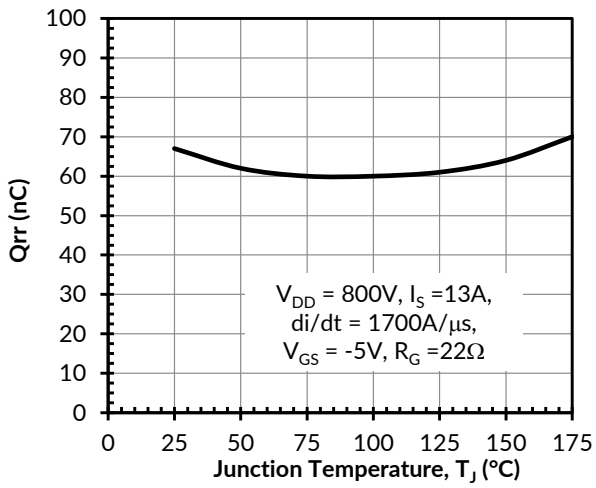

Figure 22. Reverse recovery charge Qrr vs. junction temperature

Applications Information

SiC cascodes are enhancement-mode power switches formed by a high-voltage SiC depletion-mode JFET and a low-voltage silicon MOSFET connected in series. The silicon MOSFET serves as the control unit while the SiC JFET provides high voltage blocking in the off state. This combination of devices in a single package provides compatibility with standard gate drivers and offers superior performance in terms of low on-resistance ($R_{DS(on)}$), output capacitance (C_{oss}), gate charge (Q_G), and reverse recovery charge (Qrr) leading to low conduction and switching losses. The SiC cascodes also provide excellent reverse conduction capability eliminating the need for an external anti-parallel diode.

Like other high performance power switches, proper PCB layout design to minimize circuit parasitics is strongly recommended due to the high dv/dt and di/dt rates. An external gate resistor is recommended when the cascode is working in the diode mode in order to achieve the optimum reverse recovery performance. For more information on cascode operation, see www.unitedsic.com.

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